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# 1 Nanoscale domain wall devices with magnetic 2 tunnel junction read and write

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6

7 **Fast domain wall (DW) motion in magnetic nanostructures is crucial for future spintronic device**  
8 **concepts. However, a lack of energy-efficient, scalable and industry-relevant ways to electrically**  
9 **read and write DWs in nanoscale devices impedes practical applications. Here, we demonstrate**  
10 **that full electrical control of DW devices can be achieved by incorporating typical high DW velocity**  
11 **materials (i.e., Pt/Co and synthetic antiferromagnetic (SAF) Pt/Co/Ru/Co) into perpendicular**  
12 **magnetic tunnel junctions (pMTJs). We first show tunneling magnetoresistance (TMR) readout and**  
13 **efficient spin transfer torque (STT) writing, comparable to current STT-MRAM technology. Based**  
14 **on time-resolved measurements, we find faster STT switching dynamics in the SAF-based hybrid**  
15 **free layer than in conventional dual-MgO free layer while maintaining retention stability. We**  
16 **demonstrate the full operation of DW devices at nanoscale with MTJs enabling electrical read and**  
17 **write, and a heavy metal enabling spin orbit torque (SOT)-driven DW motion for information**  
18 **transmission. Beside implications to technology and applications, we show that these devices can**  
19 **be used as a tool to explore the physics of DW dynamics at nanoscale. Furthermore, using a SAF-**  
20 **based DW conduit has the potential to enhance device performance with faster and more reliable**  
21 **DW motion. This proof-of-concept offers a pathway to the technological development of high-**  
22 **performance and low-power DW-based devices.**

23 Magnetic domain walls (DW) could form a key ingredient in next generation logic and data storage  
24 devices [ 1, 2] such as racetrack memory [ 3, 4], spin logic [ 5, 6, 7, 8] and neuromorphic computing [ 9, 10, 11].  
25 The discovery of high DW velocity governed by the Dzyaloshinskii-Moriya interaction (DMI) and spin-orbit  
26 torque (SOT) [ 12,13,14,15] in ultrathin magnetic layers on heavy metals, the additional exchange coupling torque  
27 (ECT) in synthetic antiferromagnetic (SAF) systems [ 16] and the angular momentum compensation in  
28 ferrimagnets [ 17], were major breakthroughs in the development of fast, high density, and low-energy devices  
29 based on DW motion. To enable these materials for practical application, DWs are required to be efficiently  
30 written and read at the nanoscale. However, to date, writing of DWs has mainly been performed through  
31 magnetic field-based approaches, and read out through either Hall bar devices or magnetic imaging techniques [ 5,  
32 8, 9, 12, 13, 17, 14]. These schemes play a crucial role in characterizing material properties, but their applicability

33 to DW devices at nanoscale is limited. Therefore, finding energy-efficient ways to electrically write and read DWs  
34 is a necessity for practical applications.

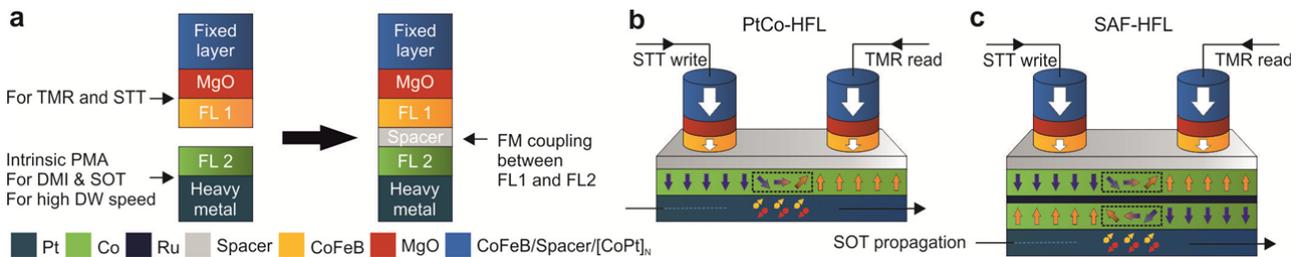
35 In this context, the magnetic tunnel junction (MTJ) can be considered as an excellent candidate. Indeed,  
36 current spin-transfer-torque magnetic random-access memory (STT-MRAM) technology has demonstrated that  
37 MTJs composed of a CoFeB/MgO-based free layer (FL) [ 18] offer uniquely high TMR readout and low STT  
38 writing current. However, the CoFeB/MgO approach faces significant challenges that relate to low DW speed [  
39 19] and poor manufacturability [ 20,21] for a DW conduit (Suppl. Mater. 2.2.).

40 In this study, we present functional DW devices with MTJs enabling electrical read and write using the  
41 hybrid free layer (HFL) design concept [ 22], allowing us to incorporate two well-known high DW velocity  
42 materials, *i.e.*, Pt/Co (PtCo-HFL) [ 12,15], and Pt/Co/Ru/Co where the thickness of Ru is varied to form a SAF- or  
43 synthetic ferromagnet (SFM)-based FL, SAF-HFL and SFM-HFL respectively [ 16, 23]. The HFL design offers a  
44 practical solution for the integration process and etch challenges of DW devices in industrial platforms (Suppl.  
45 Mater. 2.2.2) [ 21]. We validate that single MTJs with a HFL stack offer reliable TMR readout signal and efficient  
46 STT writing and could therefore be applied as inputs and outputs of a DW device. By time-resolved conductance  
47 measurements in single MTJs, we find that the Pt/Co/Ru/Co-based free layer with antiferromagnetic coupling  
48 (SAF-HFL) provides faster STT-driven switching dynamics compared to a dual-MgO reference stack. In fully  
49 integrated DW devices, we show that DWs can be locally nucleated by STT at input-MTJs and read out by TMR  
50 at output-MTJs while the DWs are directionally transported by SOT between input and output. Therefore, we  
51 demonstrate full control of a DW device, which can then be used to access both field- and SOT-driven DW  
52 dynamics at the nanoscale. Finally, we show that the HFL device proposal offers the possibility to improve DW  
53 device performance by selecting a SAF-based DW conduit.

54

55 **Hybrid free layer MTJ stack design for DW-based devices**

56 In the HFL concept, the first FL (FL1) consists of the conventional CoFeB/MgO-based FL, Fig. 1 a. The  
 57 second FL (FL2), deposited onto a heavy metal (HM), serves as the DW conduit which typically consists of a  
 58 ferromagnet [ 12], or a SAF-system [ 16]. FL2 offers high DW speed originating from interfacial DMI, SOT [ 12,  
 59 13, 14, 15] and/or ECT [ 16]. Note that the spacer material between FL1 and FL2 plays an important role in the  
 60 stack design. Firstly, it serves to decouple the crystallization of CoFeB (FL1) and FL2 as the fcc (111) crystal  
 61 structure of Co is incompatible with the bcc (001) crystal structure of CoFeB. Secondly, it enables ferromagnetic



**Fig. 1 | Schematic of hybrid free layer concept.** (a) Hybrid free layer (HFL) concept consisting of FL1 (top-left), based on CoFeB/MgO for efficient STT write and high TMR read, and FL2 (bottom-left), consisting of a material with inherent perpendicular magnetic anisotropy (PMA) which is optimized for high DW velocity driven by SOT. The two free layers are ferromagnetically coupled through a spacer layer (right). (b-c) Schematic of DW-based devices with PtCo-HFL and SAF-HFL design, respectively. FL2 consists of a Co layer on top of Pt (PtCo-HFL) or of a Co/Ru/Co structure with SFM or SAF coupling, on top of Pt (SFM-HFL or SAF-HFL).

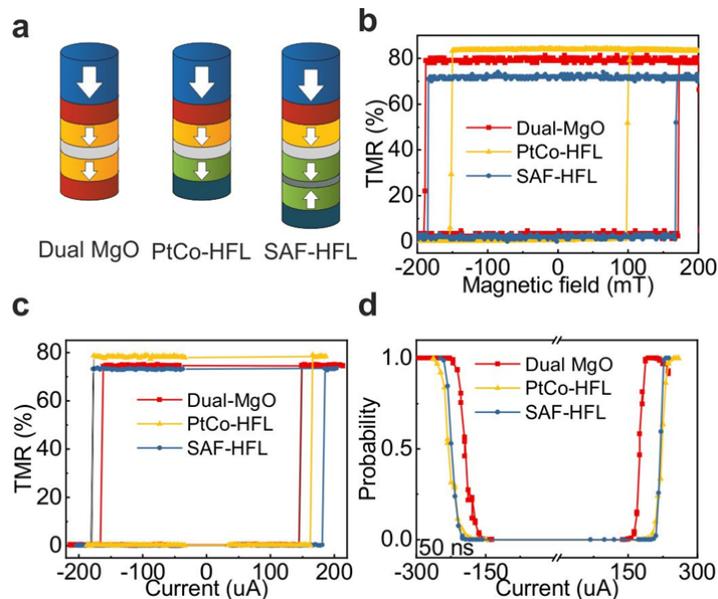
62 coupling between FL1 and FL2 by interlayer exchange coupling, so they behave as a single FL. Additionally, direct  
 63 growth of an MgO tunneling barrier with bcc (001) crystal structure on Co (FL2) is not trivial due to incompatible  
 64 crystal structure and poor electron band matching [ 22]. Therefore, incorporation of the CoFeB layer (FL1) in  
 65 contact with the MgO barrier is indispensable for retaining high TMR [ 22, 24] and high STT switching efficiency.  
 66 In principle, this approach opens the possibility of integrating any high DW speed material in FL2, including  
 67 ferrimagnets [ 25], for specific applications such as DW or skyrmion tracks [ 26,27].

68 Fig. 1 b-c illustrate the device concept with Pt/Co and Pt/Co/Ru/Co as DW conduits and MTJs as write  
 69 and read components. In this proposal, the DW device has three main components in which each one owns its  
 70 specific functionality: DW writing (*input*), DW transport (*conduit*) and DW reading (*output*). The operation  
 71 principle is as follows: STT is locally applied at the input pillar to inject DWs into the DW conduit (*i. e.*, DW

72 writing process) via the strong ferromagnetic coupling between CoFeB and FL2 (Extended Data Fig. 1 a).  
73 Subsequently, the DW travels along the track driven by magnetic field or SOT (Extended Data Fig. 1 b) (i.e., DW  
74 transport process). The detection of the DW at the output is enabled by TMR (i.e., DW reading process). As a  
75 result, this DW device concept simultaneously benefits from efficient STT switching, good TMR owing to the  
76 CoFeB/MgO interface, and high DW velocity, resulting from a combination of SOT, DMI and/or ECT in the DW  
77 conduit materials on heavy metals.

78

79 **Optimized TMR reading and fast STT writing in single MTJ pillar**

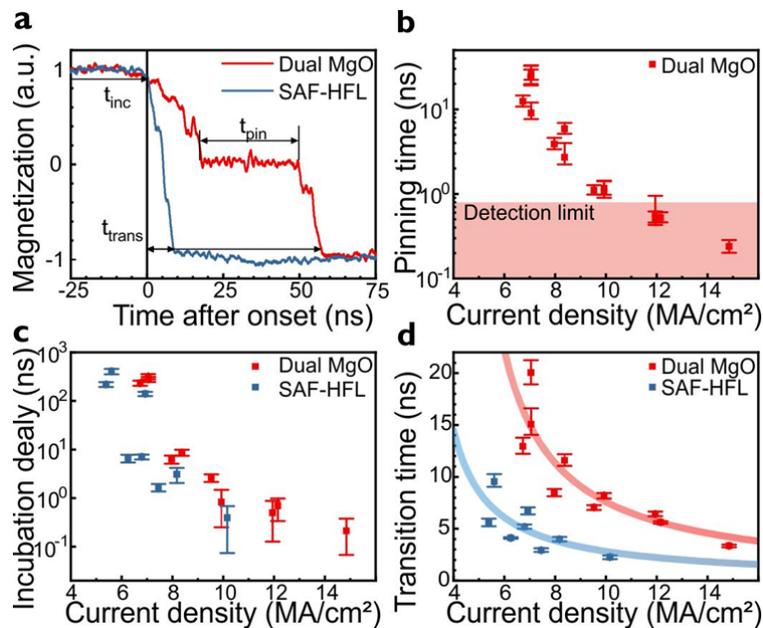


**Fig. 2 | Hysteresis loops showing reliable TMR and STT in HFL-MTJs.** (a) Illustration of standard Dual-MgO, PtCo-HFL and SAF-HFL stack, color code similar as in Fig. 1 a, (b) typical TMR loops as function of perpendicular magnetic field in MTJs with nominal diameter of 60 nm, (c) STT induced magnetization reversal at 50 ns pulse width, (d) switching probability distribution measurement averaged over 1000 events per point.

80 To verify the applicability of the HFL concept, we studied the magnetic properties of single MTJs made  
 81 with different types of HFL (Fig. 2 a), fabricated on 300 mm wafers using standard processes of MRAM  
 82 technology. Fig. 2 b-c display typical square TMR hysteresis loops of an MTJ pillar as function of field and current  
 83 pulse, respectively. Importantly, we obtain similar TMR values, about 80 %, and STT switching currents, about 200  
 84  $\mu\text{A}$ , in all types of FL. This result suggests that the obtained TMR and STT efficiency are mainly contributed by the  
 85 CoFeB/MgO/CoFeB interfaces as expected in a conventional STT-MRAM device [ 18, 28]. Note that the lower  
 86 coercivity in the PtCo- HFL device is linked to our choice of relatively low anisotropy in the stack design (Suppl.  
 87 Mater. 3.2.1). The switching probability dependence of write current amplitude (Fig. 2 d) verifies the deterministic  
 88 STT switching in all devices (Suppl. Mater. 4.3). A slightly lower write current ( $\sim 170\mu\text{A}$ ) was found in dual-MgO  
 89 devices, which may be related to the lower damping constant in CoFeB [ 29] and dual-MgO being an already  
 90 optimized stack. It is worth to note that the demonstration of good TMR read and reliable STT write in SAF-  
 91 based FL design opens the path for improving DW transport as SAF systems are expected to be less sensitive to  
 92 external perturbation and to show fast switching dynamics [ 23].

93 To evidence this statement, we compare magnetization switching dynamics of the SAF-HFL to a  
 94 standard dual-MgO based FL using timed-resolved STT-driven switching measurements. The typical time-resolved  
 95 single shot curves at room temperature, as displayed in Fig. 3 a, allow the extraction of three different timescales  
 96 for every reversal event: the initial incubation delay  $t_{inc}$  due to thermal effects, the transition time between stable  
 97 states  $t_{trans}$ , and the pinning time in a pinned state  $t_{pin}$ . For a 100 nm device size, it has been shown that the  
 98 switching process is dominated by a DW-mediated reversal [ 30]. Note that pinning only occurs in the dual-MgO  
 99 devices, as reported in Fig. 3 b. The varying nature of the pinning level and characteristic pinning timescale  
 100 indicate that the origin is most likely due to the inhomogeneities of the device microstructure. More specifically,  
 101 defects in the interfacial MgO/CoFeB anisotropy have been reported to induce pinning in the STT switching  
 102 process [ 31].

103 The incubation delays were analyzed under the assumption of a thermally activated process [ 32]  
 104  $PDF(t_{inc}) = \exp(-t_{inc}/\tau)/\tau$  where  $PDF$  is the probability density function. In the thermal limit for small drive  
 105 currents, where the incubation delay is dominant, we expect the well-known Arrhenius dependence  $\tau =$



**Fig. 3 | Fast STT switching in SAF-HFL without degradation of retention time.** (a) Typical single-shot curves of the MTJ reversal process lined up to the onset of switching (time 0), defining an incubation delay, transition time, and pinning time. (b) Extracted characteristic pinning times, only present in the dual-MgO samples. (c) The thermally activated incubation delays as function of current density, demonstrating similar behavior in the two FL designs. (d) Transition times vary as function of current density demonstrating consistently faster reversal in the devices with the proposed SAF-HFL. Error bars in all graphs define the 68% confidence interval.

I06  $\tau_0 \exp(\Delta[1 - J/J_c])$ . However, the absence of analytical expressions for  $\tau_0$  in the DW reversal regime will  
I07 prevent further parameter extraction. As displayed in Fig. 3 c, the similar incubation delay as function of applied  
I08 current indicates similar energy barriers in both stack types (Suppl. Mater. 4.4). It is supposed that in all cases the  
I09 switching process initiates in the top CoFeB layer (FL1) which is in contact with the STT source from the spin  
I10 polarization layer. Subsequently, the switching of the whole FL then follows due to the strong coupling with the  
I11 CoFeB layer. Interestingly, we found that the transition times in the SAF-based devices reduced by a factor of two  
I12 compared to their dual-MgO counterpart as seen in Fig. 3 d. This result suggests that the presence of DMI and  
I13 antiferromagnetic ECT [ 16] in our SAF-HFL devices indeed stabilize the DW configuration and lead to shorter  
I14 transition times.

I15

### I16 **Full electrical operation of DW devices with MTJ write and read**

I17 We now demonstrate that a nanoscale DW device with full control can be achieved using the HFL design. In  
I18 this study, DW devices with MTJs as electrical read and write components have been fabricated consisting of a  
I19 180 nm wide track shared by three MTJ pillars with a nominal diameter of 80 nm. The pillars are separated by 500  
I20 nm. We use a Co/Ru/Co FL2 as DW conduit with a 13 Å thick Ru-spacer which allows the formation of a  
I21 synthetic ferromagnet, SFM-HFL. In such SFM arrangement, the thicker Ru layer ensures PMA of the bottom Co  
I22 layer even when the interfacial PMA of CFB/MgO is damaged by the etching process. Importantly, the magnetic  
I23 state of the DW conduit underneath and in between pillars is very similar even if the PMA of the top Co layer has  
I24 collapsed by the etching process. Therefore, devices with SFM stack design can be used as demonstrators of SOT-  
I25 driven DW motion where the bottom Co layer is in contact with the SOT source of Pt.

I26 TMR versus field loops of three individual pillars connected by a common FL show the coercivity ( $B_C$ )  
I27 overlapping and a significant reduction of switching field (propagation field  $B_p$ ) when STT was initially applied in  
I28 one of the pillars (Extended Data Fig. 2). It indicates that the PMA of the DW conduit is fully preserved after  
I29 device integration [18]. This experiment demonstrates that three basic requirements for a functional DW device  
I30 are guaranteed, *i.e.*, PMA of the DW conduit is preserved, DWs can be locally written in the track by STT and  
I31 read out by TMR. In addition, a large difference between  $B_C$  ( $\sim 61$  mT) and  $B_p$  ( $\sim 33$  mT) provides a wide  
I32 operating window for field-driven DW transport without approaching the nucleation-dominated switching regime.

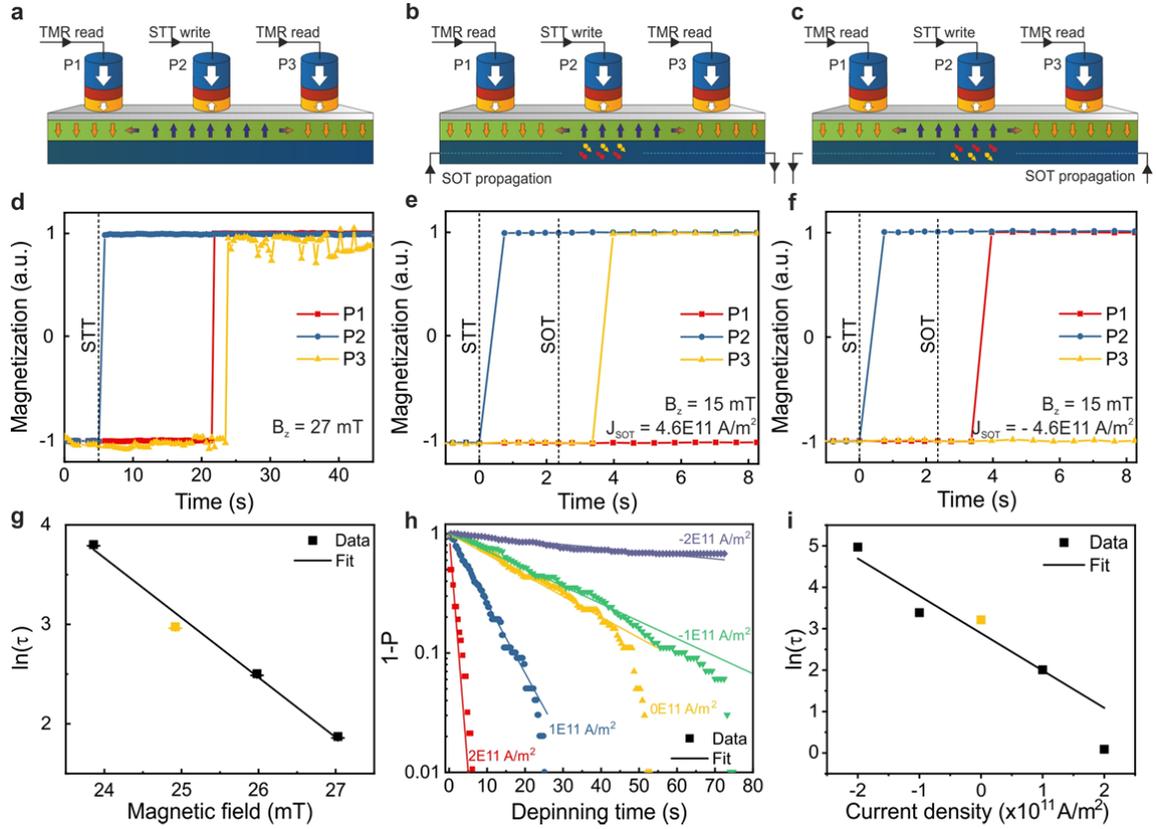
133 We now prove, Fig. 4, that the full operation of read/write using MTJs and both field and/or SOT-driven DW  
134 motion can be achieved in a single DW device. Experimentally, the measurement sequence of a DW device with  
135 the track shared by three MTJ pillars is summarized as follows. We firstly saturate the device in the parallel (P)  
136 state by a negative external field larger than the coercivity. Consecutively, STT is used to selectively write an  
137 antiparallel (AP) domain in the center pillar P2, as seen in Fig. 4 **d-e-f** by an abrupt change of magnetization from P  
138 to AP in P2 (blue graph). Finally, the motion of DWs through the track induced by field and/or SOT is detected by  
139 TMR in the neighboring pillars. Fig. 4 **a, d** shows an example of field-driven DW transport in which the device is  
140 operated at a constant field of 27 mT ( $\ll B_c \sim 61\text{mT}$ ). In this case, the nucleated domain expands from the  
141 center pillar to both outer pillars driven by field and assisted by thermal activation. The result of DW motion  
142 along the track is observed by TMR read as a change of magnetic state from P to AP in both P1 and P3,  
143 demonstrating the isotropic nature of field-driven transport.

144 We now demonstrate that our DW devices can be operated by applying an in-plane SOT current along the  
145 track as shown in Fig. 4 **b, c, e** and **f**. In contrast to field-driven DW transport, the direction of DW motion is  
146 selectively manipulated by the current polarity. As seen in Fig. 4 **b, e**, we observe a change of TMR in P3  
147 indicating DW motion from P2 to P3 with a positive current. Similarly, Fig. 4 **c, f** shows DW motion from P2 to  
148 P1 with negative current. Note that we never observe DW motion against the direction of current flow as no  
149 switching occurs at P3 (P1) with negative (positive) current (*c.f.*, Fig. 4 **e, f**). To verify the device operation  
150 reliability, we show in Extended Data Fig. 3 that the experiments are reproducible  $\sim 100$  times.

151 The observation of DW motion along the current flow provides clear evidence that SOT originating from Pt  
152 is the main driving force for DW motion in our devices as expected in stand-alone samples [10-13]. In this  
153 experiment, the exact shape of the nucleated domain is not obvious since TMR readout is locally sensitive to a  
154 change of magnetization state underneath the pillars. However, we believe that a magnetic bubble was fully  
155 nucleated under the MTJ as a full switching of MTJ resistance from P to AP is always present after STT write.  
156 Also, we do not observe any change of the resistance in the neighbouring pillars during STT write meaning that a  
157 domain is locally injected underneath the MTJ. In other words, two DWs are expected to form on each side of  
158 the MTJ pillar. It is worth to mention that we do not observe two changes of resistance (*i.e.*, drop of resistance in  
159 the input pillar and rise in resistance in output pillar) as would be expected from SOT-driven DW motion (Suppl.

160 Mater. 6.4). It might be due to the fact that the externally applied field favors bidirectional expansion while the  
161 SOT-driven DW motion favors unidirectional motion (c.f., Fig. Suppl. 6.4). We believe that fine-tuning of the  
162 device integration process will reduce the potential DW pinning sites of the track at nanoscale such that the  
163 device can be fully controlled by SOT without external field, as we obtained in the case of stand-alone FL samples  
164 (Fig. Suppl. 6.3).

165 Our devices also allow to control DW motion from any pillar in the track. We show in a slightly larger device  
166 (track width 200 nm, pillar diameter 100 nm and interpillar spacing 500 nm) that SOT-driven DW motion can be  
167 achieved from any pillar where the DW is initially written by STT (Extended Data Fig. 4). This demonstration  
168 provides an important feature for practical application of spintronic devices, for instance the operation of spin  
169 logic devices which require DWs to be independently controlled from different inputs [ 6, 8].



**Fig. 4 | Full operation of a DW device with MTJs enabling STT write and TMR readout and SOT-driven DW transport.** (a-c) Schematics explaining DW transport as observed in (d-f) respectively. (a,d) Field-driven domain expansion from P2 to both P1 and P3. (b, e) SOT-driven DW motion from P2 to P3 with positive current flow in the heavy metal and (c, f) SOT-driven transport from P2 to P1 with negative current. (g) Natural logarithm of the depinning time as function of external magnetic field. (h) Cumulative density functions (plotted as 1-CDF on logarithmic scale) of depinning time at a fixed field of 24.9 mT and varying current density obtained from 100 measurements at each current density and polarity. The data is fitted by an exponential law, resulting in the average depinning times as plotted in (i) as function of current.

170 In addition, we prove that such devices offer the possibility to explore DW dynamics in a full operation mode  
 171 where imaging techniques become ineffective in fully integrated devices at low dimension. For this study, we  
 172 repeat a similar experiment as seen in Fig. 4 a and measure the waiting time for the DW to overcome the energy  
 173 barrier to travel from P2 (i.e., where DW is written by STT) to P3 (i.e., where DW is detected by TMR read) with  
 174 the assistance of external field and thermal activation. We choose four different external field values to tune the  
 175 height of the energy barrier and repeat the measurement 100 times to characterize the statistics of the depinning

176 time at each field value (Fig. Suppl. 6.2.1). The cumulative distribution function (CDF) of depinning time for each  
 177 field value is well described by a single exponential law,  $CDF(t) = 1 - \exp(-t/\tau)$  with the characteristic  
 178 depinning time  $\tau$ , as theoretically predicted for DW depinning processes [ 33, 34]. Fig. 4 g shows the obtained  $\tau$   
 179 (on ln-scale) as a function of magnetic field, fitted by an Arrhenius-law-based exponential equation  $\tau =$   
 180  $\tau_0 \exp\left(\frac{E}{k_B T} (1 - B/B_{C0})\right)$ , where  $B_{C0}$  is the intrinsic critical field in the absence of thermal activation [ 33]. We  
 181 obtain a thermal stability factor  $\frac{E}{k_B T}$  of  $38.8 \pm 1$ .

182 Finally, we use such devices as a tool to study the impact of SOT on the DW dynamics in full operation,  
 183 where the DW is electrically read and written using MTJs. We carry out similar field induced DW depinning  
 184 measurements and now add SOT on top of a fixed external field of  $24.9 \text{ mT}$ . Fig. 4 h displays the CDF of  
 185 depinning times (on log scale) at varying current density and polarity. As expected, a negative current increases  
 186 the DW depinning time while a positive current decreases the depinning time (Fig. Suppl. 6.2.2). We find that the  
 187 CDF of SOT induced DW depinning can also be fitted by a single exponential as expected for DW depinning over  
 188 a single barrier. It suggests that the application of SOT does not change the nature of DW dynamics in our device.  
 189 When plotting the obtained depinning time  $\tau$  (on ln-scale) as function of current density (Fig. 4 i), we find that the  
 190 effect of SOT on the DW depinning dynamics is equivalent with field-driven depinning. Therefore, we assume  
 191 again an Arrhenius-law based exponential, including the effect of current  $\tau = \tau_0 \exp\left(\frac{\Delta}{k_B T} \left[1 - \frac{B}{B_C} - \frac{J}{J_C}\right]\right)$  [ 34] and  
 192 approach the effect of current similar to magnetic field. We then obtain  $\tau = \tau_0 \exp\left(\frac{\Delta}{k_B T} \left[1 - \frac{B - \epsilon J}{B_C}\right]\right)$  which allows  
 193 to estimate the SOT efficiency  $\epsilon$  on the DW depinning process:  $\epsilon = 1.5 \pm 0.24 \text{ mT} \times (10^{11} \text{ Am}^{-2})^{-1}$ . This is  
 194 in agreement with literature for PtCo-based stand-alone samples [ 34], which indicates that the nature of DW  
 195 dynamics in the conduit layer is retained in nanoscale devices under both field and SOT-driven DW depinning.

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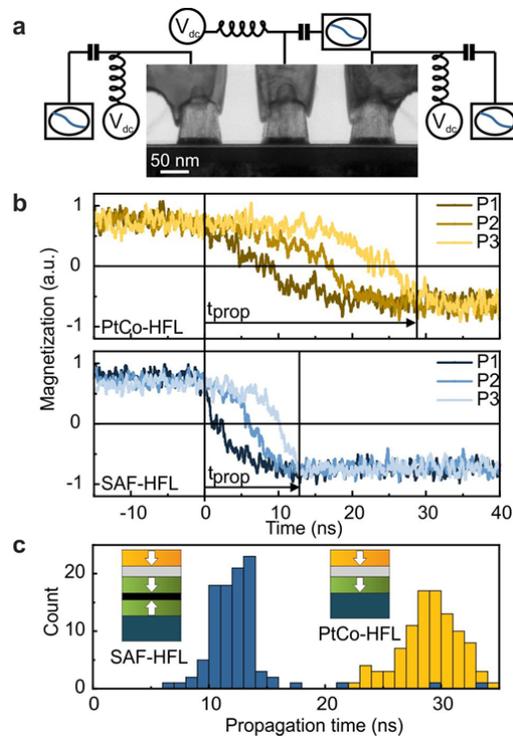
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200 **Toward improvements of DW device performance with SAF-HFL design**

201 The HFL proposal allows to improve device performance, for instance by integration of a SAF system as  
 202 DW conduit. For this purpose, a softer etching condition in the device integration process was used. Etching was  
 203 stopped in the reference layer (RL) above the MgO barrier to avoid any magnetic damage to the SAF-based DW  
 204 conduit, *i.e.*, to the CoFeB/MgO interface of FLI. Note that this etch-stop condition induces an electrical short  
 205 between the pillars through the RL. We believe that it does not impact the demonstration of field-driven DW  
 206 motion in this study. We compare the dynamics of field-driven DW motion along PtCo-HFL and SAF-HFL  
 207 conduits in a 170 nm wide track shared by three MTJs, using real-time TMR detection, Fig. 5 a (Suppl. Mater. 6.1).  
 208 The time resolved single-shot curves in Fig. 5 b show a sequential switching of pillars P1, P2 and P3 under the  
 209 application of the sweeping magnetic field. It suggests that at coercivity, a domain is nucleated and sequentially



**Fig. 5 | Fast DW propagation in SAF-HFL compared to PtCo-HFL.** (a) Cross-sectional TEM image of 3 MTJs with a nominal diameter of 70 nm and interpillar spacing of 100 nm sharing the same FL. Bias tees enable individual DC and high-frequency access to each pillar. (b) Single-shot time-resolved field-driven magnetization reversal at coercivity in PtCo-HFL (42.5 mT) and SAF-HFL (63 mT), (c) Propagation time measured from 100 measurements as in b, showing shorter propagation time in SAF-HFL.

210 expanded throughout the DW conduit. This measurement reveals that the dynamics of DW motion in high DW

211 speed materials, more specifically in CoPt or in the Co-based SAF system, can be sensed by TMR detection in  
212 nanoscale devices. The propagation time, defined as the delay-time between the onset of reversal in P1 and the  
213 termination of reversal in P3, is at least double in PtCo-HFL ( $28.99 \pm 2.63$  ns) as compared to SAF-HFL ( $13.09 \pm$   
214  $5.48$  ns). It means that DW motion in SAF-based devices with an average DW velocity of 42 m/s, is faster than in  
215 PtCo-based devices with an average DW velocity of 17 m/s. Faster DW motion in SAF is attributed to the  
216 combination of DMI and interlayer exchange coupling which helps to stabilize the DW structure during its motion  
217 thus extending the steady motion regime to larger fields compared to its ferromagnetic counterpart. Note that  
218 our SAF is not fully compensated (Fig. Suppl. 3.2.2) and that the effect of field on DW motion will be less sensitive  
219 if the SAF system is more compensated urging for SOT- rather than field-driven DW motion. Thus, we finally  
220 study SOT-driven DW motion in a stand-alone SAF-FL by Kerr microscopy. We indeed observe uniform (Suppl.  
221 Video) and fast SOT-driven motion (DW velocity up to  $460$  m/s at  $J = 3 \times 10^{12}$  A/m<sup>2</sup>) in a SAF-based sample (Fig.  
222 Suppl. 6.3). This suggests that a SAF-based DW conduit could enable higher performance DW devices. Therefore,  
223 we believe that fine-tuning the MTJ stack design and improving etching conditions to ensure the PMA of the full  
224 SAF structure will be key for fast SOT-driven DW motion devices.

225

## 226 **Conclusions**

227 In summary, we experimentally demonstrated the full operation of a DW device using the HFL-MTJ  
228 concept which can provide all requirements for high density and low power DW-based devices including STT  
229 write, TMR read and SOT-driven DW motion. This device provides a way to study the physics of DW dynamics  
230 under both field and/or SOT at the nanoscale. Moreover, we showed that SAF-based DW conduit devices offer a  
231 significant advantage compared to their ferromagnetic counterpart thanks to the characteristic properties of  
232 antiferromagnetic materials. These include faster STT writing speed in a single MTJ device and uniform and fast  
233 DW motion in the SAF-based DW conduit devices. Therefore, in combination with an optimized manufacturing  
234 process of nanoscale devices, we believe that this HFL device concept not only leads the way towards the  
235 practical realization of DW-based devices but also shows promise for the development of other potential  
236 spintronic devices, such as skyrmion and spin-wave based devices.

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238

## 239 **Methods**

240 **Sample fabrication:** All devices were fabricated in imec's 300 mm pilot line. First, a buried bottom electrode  
241 contact (BEC) process was used to define the bottom electrode. Here, single damascene W metallization was  
242 applied two times, first to define BEC feedlines and second to define contact plugs. Next, the W contact plugs  
243 were capped by an ultra-smooth TaN seed layer prior to MTJ deposition. The stack is deposited using an  
244 ultrahigh vacuum (UHV) multitarget magnetron sputtering system at room temperature without breaking vacuum  
245 between depositions (EC7800 Canon-Anelva). Pillars were patterned by 193 nm immersion lithography and a  
246 subsequent ion-beam-etch (IBE) at normal and grazing angle for single pillar and DW devices. The DW devices  
247 required additional 193 nm immersion lithography double patterning to further define the free layer shape. Finally,  
248 dual damascene Cu top contacts were fabricated to provide electrical readout at the individual pillars. The dual

249 MgO FL stack, PtCo-HFL stack, SAF-HFL and SFM-HFL stack consist from bottom to top, of  
250  $\text{Co}_{20}\text{Fe}_{60}\text{B}_{20}(9)/\text{Mg}(6)/\text{Ta}(3)/\text{Co}_{20}\text{Fe}_{60}\text{B}_{20}(11)/\text{MgO}(10)$ , of  $\text{Pt}(30)/\text{Co}(8)/\text{W}(3)/\text{Co}_{20}\text{Fe}_{60}\text{B}_{20}(8)/\text{MgO}(10)$ ,  
251  $\text{Pt}(30)/\text{Co}(8)/\text{Ru}(8.5)/\text{Co}(6)/\text{W}(3)/\text{Co}_{20}\text{Fe}_{60}\text{B}_{20}(8)/\text{MgO}(10)$ , and of  
252  $\text{Pt}(30)/\text{Co}(8)/\text{Ru}(13)/\text{Co}(6)/\text{W}(3)/\text{Co}_{20}\text{Fe}_{60}\text{B}_{20}(8)/\text{MgO}(10)$ , respectively. Thicknesses in brackets are provided in  
253 Angstrom. The magnetic hard layer (HL) consists of a  $\text{Co}_{17.5}\text{Fe}_{52.5}\text{B}_{30}$  reference layer (RL) which is  
254 ferromagnetically coupled to a SAF that consists of  $\text{Co}(12)/\text{Ru}(8.5)/\text{Co}(6)/\text{Pt}(8)/[\text{Co}(3)/\text{Pt}(8)]_6$ . More information on  
255 the fabrication process can be found in [ 21].

256 **Electrical setup:** A detailed scheme of the electrical setup of Fig. 3 is provided in Fig. Suppl. 5.1, this setup  
257 allows time-resolved measurements of STT-driven magnetization reversal in single pillars. The measurements  
258 were performed on high-frequency capable 100 nm pillars. By applying voltage pulses of varying amplitude and  
259 short ramp time ( $\sim 300$  ps) we could study the magnetization dynamics down to the nanosecond regime. The  
260 magnetic offset field was compensated for by an external magnetic field during the STT-driven reversal. Prior to  
261 the recording of the single shot data, two reference traces were recorded for the P and AP state as described in  
262 Suppl. Mater. 5. The single shot data travels between the two recorded reference states, which allow the  
263 normalization of the single shot data, as shown in Fig. Suppl. 5.2. For each point in Fig. 3, 100 single shots were  
264 recorded.

265 The electrical setup for the DW devices in Fig. 4, consists of a source measure unit (SMU) at each pillar, allowing  
266 individual STT-writing and TMR readout in each pillar. An additional SMU is connected to the track to allow in-  
267 plane current in the heavy metal. To avoid erroneous signals during SOT-driven DW transport, SMUs at the MTJs  
268 are kept floating while a current (100 ms) is applied through the track. Consecutively, each pillar is read out.

269 The electrical setup in Fig. 5, consists of radiofrequency and DC paths enabled by bias tees at each pillar. A DC  
270 bias is applied at every pillar during magnetization reversal driven by field. At coercivity, the resistance of the pillar  
271 suddenly changes leading to a reflection of the applied current. The recorded rf voltages measured by the 25 GHz  
272 oscilloscope then equal the reflected rf current multiplied by the  $50 \Omega$  termination of the scope channels.

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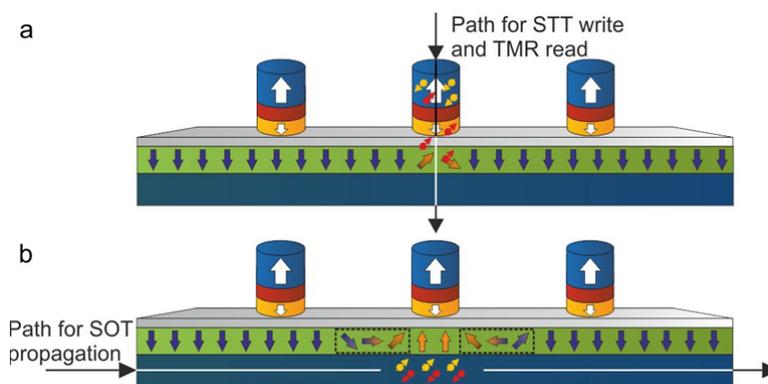
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278

279 **Author contributions** V.D.N. and S.C. conceived the HFL device concept and managed the project. E.R. and  
280 V.D.N performed the SOT-driven DW measurements, E.R., O.B., V.D.N and T.D. performed the time-resolved  
281 experiments and interpreted the results with help of K.G., S.C., D.W., I.R., I.A, I.Y., D.N., B.S. and M.H.; Device  
282 integration was performed by D.W., Y.C., L.S., A.T. and D.T.; The thin films were deposited by S.C.; E.R., O.B.,  
283 K.G. and V.D.N. wrote the manuscript. All authors discussed the results and commented on the manuscript.

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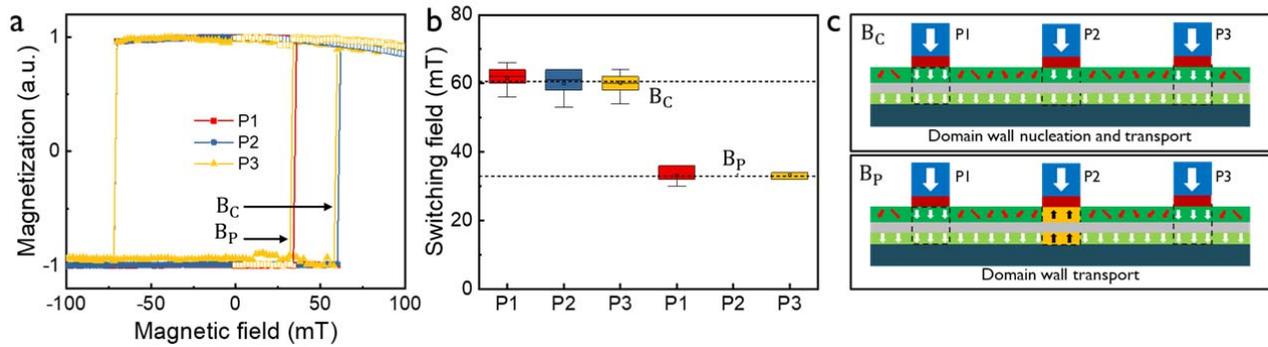
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**Extended Data Fig. 1 | Representation of current flow.** Current path for reading and writing displayed for center pillar (a) and for DW motion driven by SOT (b).

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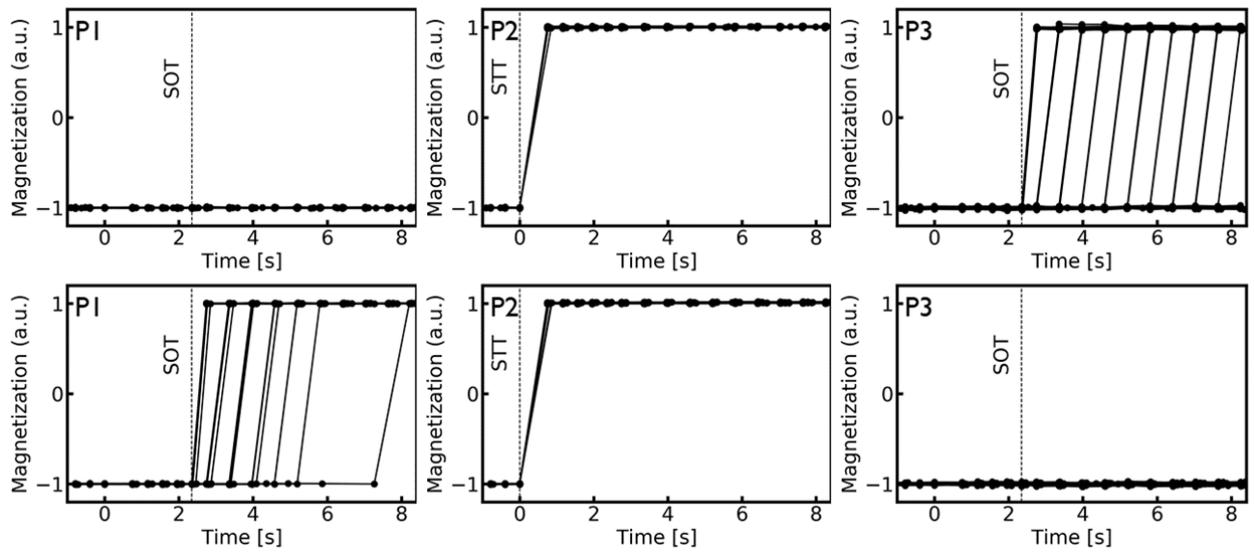
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**Extended Data Fig. 2 | Comparison of coercive field and propagation field.** (a) The coercive field  $B_C$  is the switching field obtained during a conventional RH loop. The propagation field  $B_P$  is obtained after STT-driven nucleation in the center pillar (P2) and consecutive sweeping of the z-field from 0 mT upwards. The domain then expands to the outer pillars (P1 and P3). (b) Box plots of the coercive and propagation fields of 10 measurements. The average coercive field is 61 mT while the propagation field to both pillars is only 33 mT. (c) Demonstration of the initial state of the device before the RH loops is initiated. Device is fully saturated to obtain coercive field  $B_C$  (top), a domain was initially nucleated in P2 to obtain the propagation field  $B_P$  (bottom).

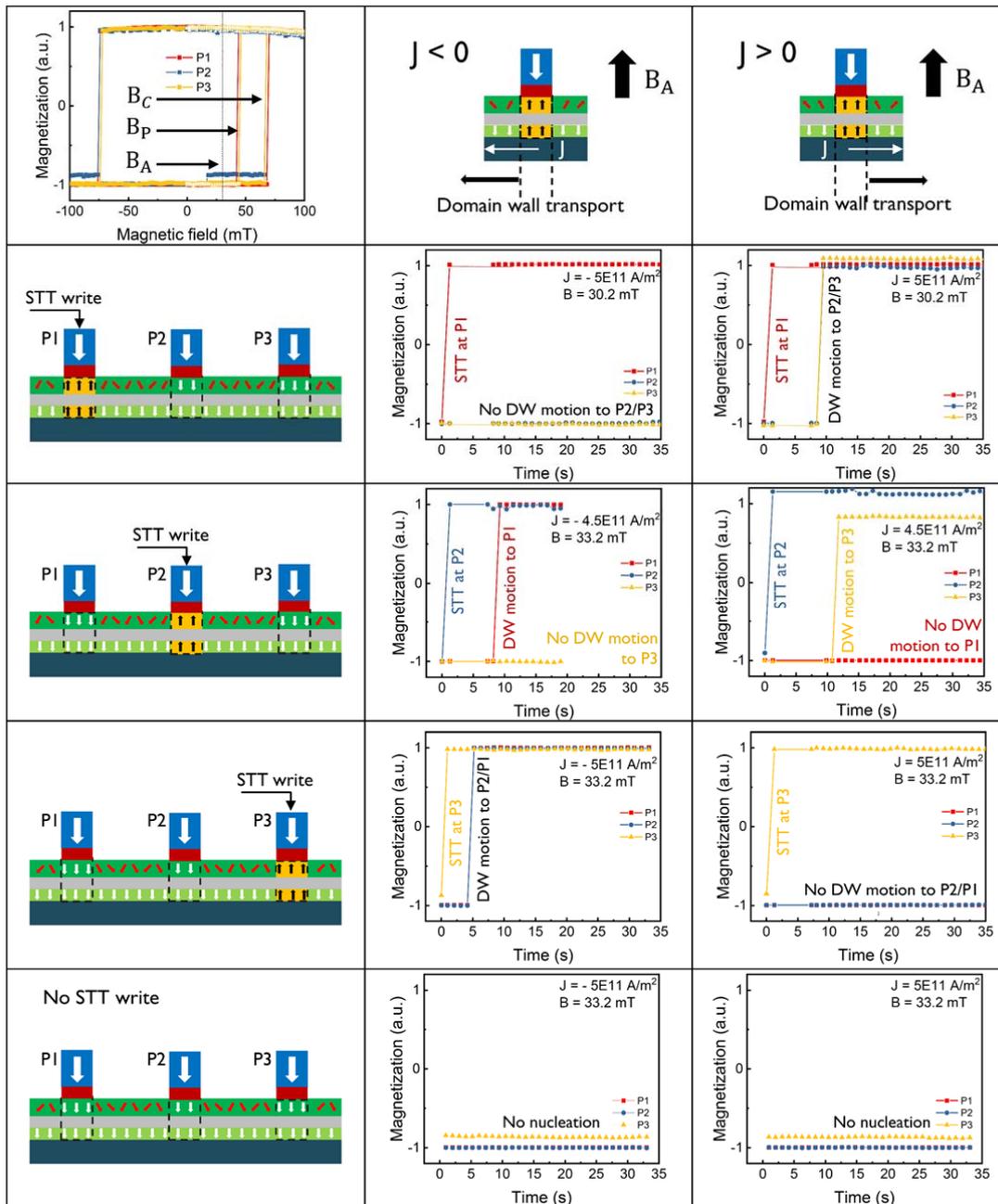
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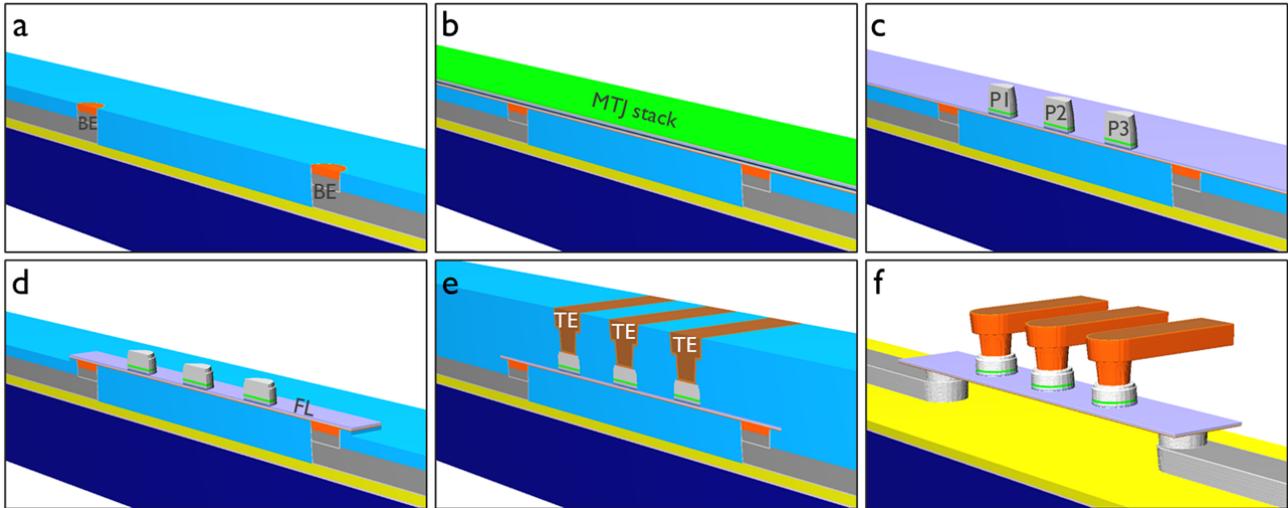
**Extended Data Fig. 3 | ~100 x reproducibility of SOT-driven DW transport as in Fig. 4 e, f, STT nucleation in P2 followed by SOT-transport to P3 with positive current (top) and SOT transport to P1 with negative current (bottom). Measurement ~100 x reproducible with each current polarity. The DW never propagates to the reverse direction, i.e. no switch in P1 (top) and P3 (bottom).**

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**Extended Data Fig. 4 | Full demo of SOT-driven transport starting from each pillar.** (Top left)

Resistance versus field loop displays the coercive field  $B_C$ , the propagation field  $B_P$  and the assist field  $B_A$  for SOT-driven transport. The schematics at the top display the applied current polarity and direction of DW motion. The domain is nucleated by STT in P1 (second row), P2 (third row), and P3 (fourth row) as shown by the schematics on the left. In the last case (fifth row), no domain is nucleated by STT. The latter confirms that all the above are SOT-driven propagation of DWs, and not SOT-driven switching.



**Extended Data Fig. 5 | Fabrication process in imec’s 300 mm pilot line.** (a) Bottom electrode contact (BEC), BEC feedlines and contact plugs were defined. (b) MTJ stack deposition using UHV magnetron sputtering system (c) Pillar patterning by 193 nm immersion lithography followed by ion-beam-etch (IBE) (d) FL shape is defined by 193 nm immersion lithography double patterning (e) Dual damascene Cu top contact formation (f) 3-dimensional image of DW device with individual TE for each pillar.